

DM74AS1000A Quadruple 2-Input NAND Driver

General Description

These devices contain four independent 2-input drivers, each of which performs the logic NAND function. The DM74AS1000A is a driver version of the DM74AS00. Each driver has increased output drive capability to allow the driving of high capacitive loads.

Features

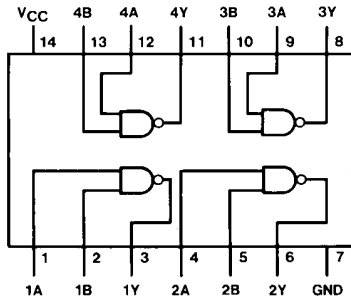
- Switching specifications at 50 pF
- Switching specifications guaranteed over full temperature and V_{CC} range
- Advanced oxide-isolated, ion-implanted Schottky TTL process
- Improved line receiving characteristics

Ordering Code:

Order Number	Package Number	Package Description
DM74AS1000AM	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
DM74AS1000AN	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Function Table

$$Y = \overline{AB}$$

Inputs		Output
A	B	Y
L	L	H
L	H	H
H	L	H
H	H	L

H = HIGH Logic Level
L = LOW Logic Level

Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	-65°C to +150°C
Typical θ_{JA}	
N Package	76.0°C/W
M Package	106.0°C/W

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V _{CC}	Supply Voltage	4.5	5	5.5	V
V _{IH}	HIGH Level Input Voltage	2			V
V _{IL}	LOW Level Input Voltage			0.8	V
I _{OH}	HIGH Level Output Current			-48	mA
I _{OL}	LOW Level Output Current			48	mA
T _A	Free Air Operating Temperature	0		70	°C

Electrical Characteristics

over recommended operating free air temperature range. All typical values are measured at V_{CC} = 5V, T_A = 25°C.

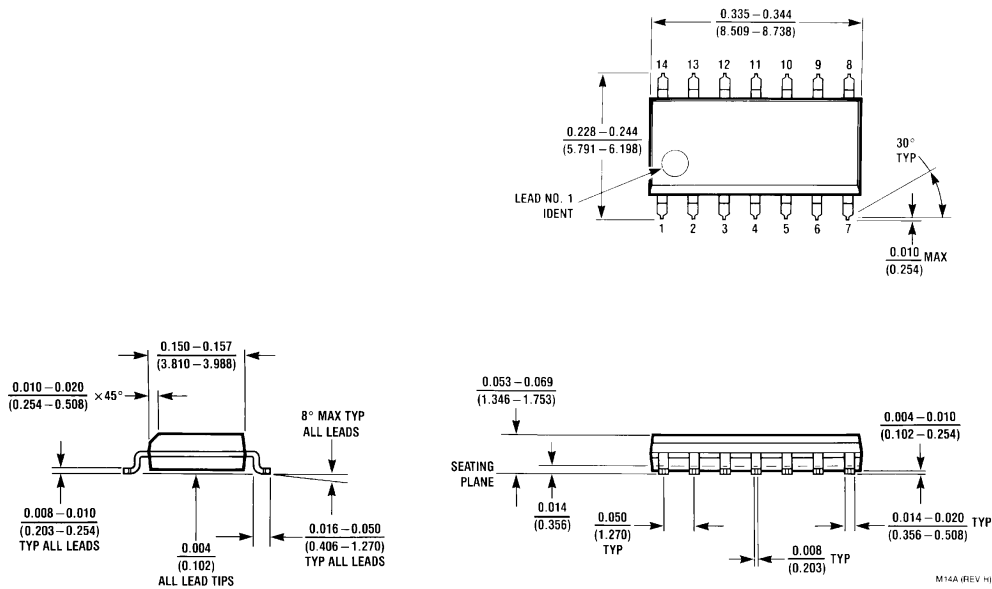
Symbol	Parameter	Conditions	Min	Typ	Max	Units
V _{IK}	Input Clamp Voltage	V _{CC} = 4.5V, I _I = -18 mA			-1.2	V
V _{OH}	HIGH Level Output Voltage	V _{CC} = 4.5V	I _{OH} = -3 mA	2.4	3.2	V
		V _{IL} = Max	I _{OH} = Max	2		
		I _{OH} = -2 mA, V _{CC} = 4.5V to 5.5V		V _{CC} - 2		
V _{OL}	LOW Level Output Voltage	V _{CC} = 4.5V, V _{IH} = 2V		0.35	0.5	V
		I _{OL} = Max				
I _I	Input Current @ Max Input Voltage	V _{CC} = 5.5V, V _{IH} = 7V			0.1	mA
I _{IH}	HIGH Level Input Current	V _{CC} = 5.5V, V _{IH} = 2.7V			20	μA
I _{IL}	LOW Level Input Current	V _{CC} = 5.5V, V _{IL} = 0.4V			-0.5	mA
I _O	Output Drive Current	V _{CC} = 5.5V, V _O = 2.25V	-50	-135	-200	mA
I _{CCH}	Supply Current	Outputs HIGH, V _{CC} = 5.5V, V _I = 0V		2.3	3.5	mA
I _{CCL}	Supply Current	Outputs LOW, V _{CC} = 5.5V, V _I = 4.5V		11.5	19	mA

Switching Characteristics

over recommended operating free air temperature range

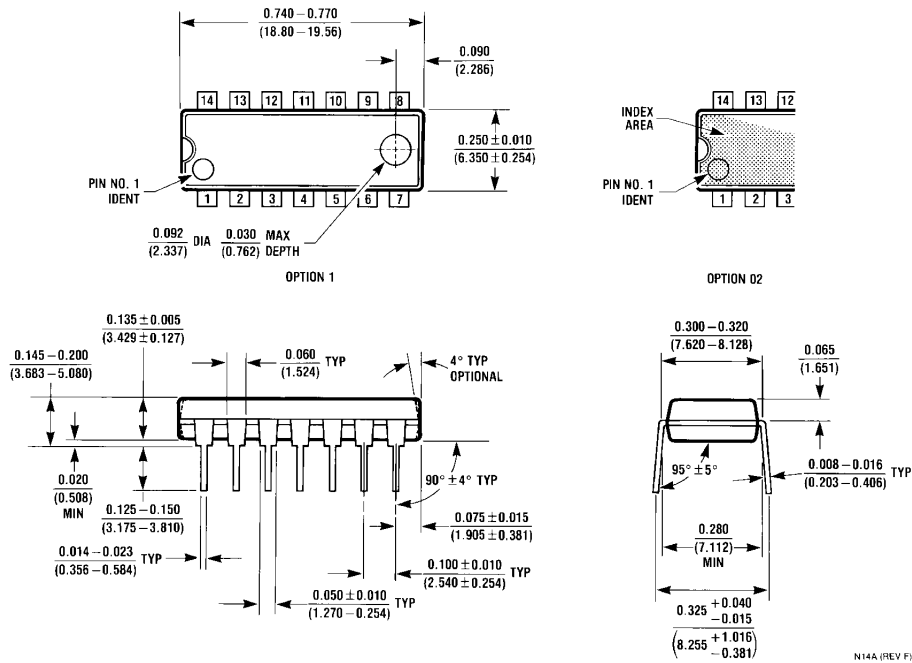
Symbol	Parameter	Conditions	Min	Max	Units
t _{PLH}	Propagation Delay Time	V _{CC} = 4.5V to 5.5V R _L = 500Ω	1	4	ns
	LOW-to-HIGH Level Output				
t _{PHL}	Propagation Delay Time	C _L = 50 pF	1	4	ns
	HIGH-to-LOW Level Output				

Physical Dimensions inches (millimeters) unless otherwise noted



**14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M14A**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N14A

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com